# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

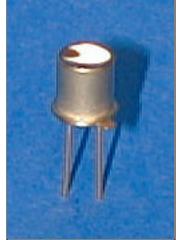


## Contact us

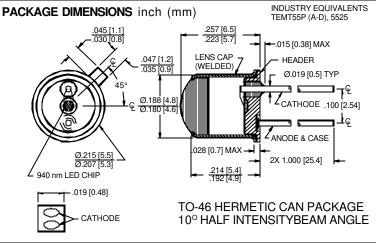
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



### PHOTONIC DETECTORS INC.



**High-Power & Current GaAs Infrared Emitters** Peak Wavelength, 940 nm, Type PDI-E913



#### **FEATURES**

- Dual cathode
- High current
- power, and high current at 940 nm. Packaged in a • Medium-high emission angle

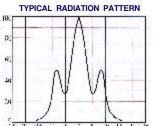
### DESCRIPTION: The PDI-E913 infrared emitting APPLICATIONS diode uses dual cathode, high current liquid

 Photoelectric switches phase epitaxially grown GaAs. Optimized for high

- **Reflective switches**
- Smoke detectors

Medium-nign emission angle TO-46 can with a glass lens cap.
ABSOLUTE MAXIMUM RATING (TA=25°C unless otherwise noted)

SYMBOL	PARAMETER	MIN	MAX	UNITS
Pd	Power Dissipation		360	mW
I <sub>FP</sub>	Continuous Forward Current		180	mA
I <sub>EP</sub>	Peak Forward Current (100µs pulse,10pps	)	3.0	A
V <sub>B</sub>	Reverse voltage		3.0	V
To & Ts	Storage & Operating Temperature	-65	+125	°C
TS	Soldering Temperature*		+260	°C
1/16 inch from case for 3 secs max				

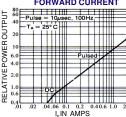


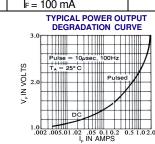
BEAM ANGLE, 0 (deg)

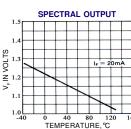
ELECTRO-OPTICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

SYMBOL CHARACTERISTIC TEST CONDITIONS MIN TYP MAX UNITS Po Output Power l⊧ = 100 mA 1.0 5.0 mW VF l⊧ = 100 mA 1.75 Forward Voltage 1.35 V **Reverse Current**  $V_{R} = -3.0 V$ mA R 10 955 λP Peak Wavelength l⊧ = 50 mA 925 940 nm Dλ Spectral Halfwidth l⊧ = 50 mA 50 nm Dynamic Resistance L = 100 mA0.6 Rd Ohm **Rise Time** l⊧ = 100 mA μS tr 1.1 tr Fall Time l⊧ = 100 mA 1.5 mS









Information in this technical data sheet is believed to be correct and reliable. However, no responsibility is assumed for possible inaccuracies or omission. Specifications are subject to change without notice. Optical power and radiant intensity measured using uncapped dimpled TO-46 into integrating sphere.